

#### **FEATURES**

Low Reverse Leakage

High Forward Surge Capability

**MECHANICAL DATA** 

High Reliability





Schematic Symbol

### **APPROVALS**

Case: SMA-W	RoHS	Compliance with 2011/65/EU
Polarity: Color Band Denotes Cathode End		Compliance with IEC61249-2-21:2003
Mounting Position: Any		

# ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

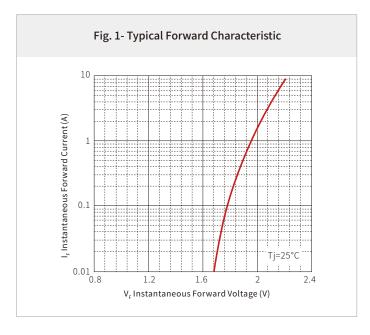
Parameter		Symbol	EM530S	Unit
Marking			EM530S	
Maximum Repetitive Peak Reverse	e Voltage	V <sub>RRM</sub>	3000	V
Maximum RMS Voltage		V <sub>RMS</sub>	2100	V
Maximum DC Blocking Voltage		V <sub>DC</sub>	3000	V
Maximum Average Forward Rectified Current		I <sub>F(AV)</sub>	0.5	А
Non-repetitive Peak Forward Surge Current 8.3 ms Singlehalf Sine-Wave		I <sub>FSM</sub>	20	А
Maximum Forward Voltage@I <sub>F</sub> =0.5A		V <sub>F</sub>	2.2	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	T <sub>A</sub> =25°C	I <sub>R</sub>	5	μΑ
	T <sub>A</sub> =125°C		300	
Typical Thermal Resistance (Note 1)		$R_{\theta JA}$	65	°C/W
Type Junction Capacitance V <sub>R</sub> =4.0v,f=1MHz		C	35	pF
Operating Junction Temperature Range		T <sub>J</sub>	-55 to +150	°C
Storage Temperature Range		T <sub>STG</sub>	-55 to +150	°C

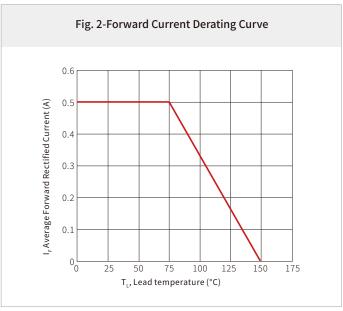
Notes:

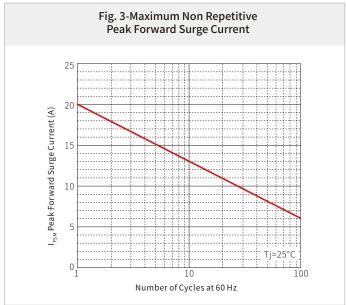
<sup>1)</sup> Thermal resistance from junction to ambient, PCB mounted

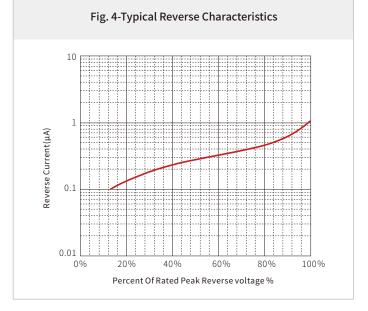


### **CHARACTERISTIC CURVES**







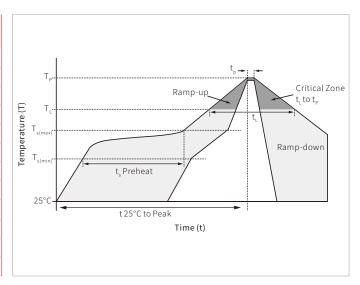


Inches

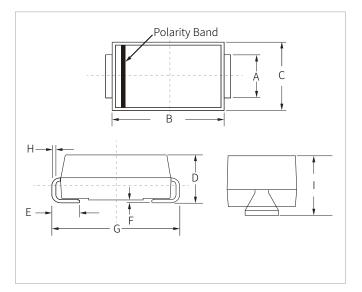


### **SOLDERING PARAMETERS**

	Reflow Condition	Lead-free assembly
	$TemperatureMax(T_{s(min)})$	150°C
Pre Heat	Temperature Max $(T_{s(max)})$	200°C
	Time (min to max) $(t_s)$	60 – 180 secs
Average rar	np up rate (Liquidus Temp ( $T_{L}$ ) to peak	3°C/second max
	$T_{s(max)}$ to $T_L$ - Ramp-up Rate	3°C/second max
Reflow	Temperature (T <sub>L</sub> ) (Liquidus)	217°C
Rellow	Time (min to max) $(t_L)$	60 – 150 seconds
Peak Ten	nperature (T₅)	260°C
Time with	nin 5°C of actual peak Temperature (t <sub>p</sub> )	20 – 40 seconds
Ramp-do	own Rate	6°C/second max
Time 25°	C to peak Temperature (T♭)	8 minutes max.
Do not ex	cceed	260°C



### **SMA-W PACKAGE INFORMATION**

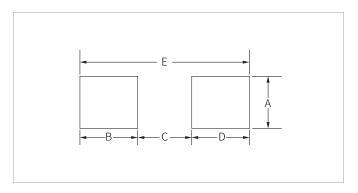


Ref.					
i.c.i	Min.	Max.	Min.	Max.	
А	1.20	1.60	0.047	0.063	
В	4.20	4.60	0.165	0.181	
С	2.60	2.80	0.102	0.110	
D	2.10	2.40	0.083	0.094	
Е	0.76	1.52	0.030	0.060	
F	0.02	0.20	0.001	0.008	
G	4.85	5.25	0.191	0.207	
Н	0.15	0.30	0.006	0.012	
I	1.90	2.40	0.075	0.094	

Millimeters



### **RECOMMENDED PAD LAYOUT DIMENSIONS**



Ref.	Millimeters		Inches		
ici.	Min.	Max.	Min.	Max.	
А	1.63	-	0.064	-	
В	1.45	-	0.057	-	
С	-	2.80	-	0.090	
D	1.45	-	0.057	-	
Е	5.28REF		0.208REF		

### **ORDERING INFORMATION**

Part Number	Size	QTY/Reel	Reel Size
EM530S	SMA-W	5000PCS	13"



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#### By QR Code





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